## IN THE CLAIMS

Please cancel Claims 1-4 without prejudice.

## 1-4. (Cancelled)

- 5. (Original) An active matrix pixel device comprising a plurality of polycrystalline silicon islands supported by a substrate (14), one of the islands providing a channel (15) and doped source/drain regions (16,17) of a thin film transistor (10), the device further comprising a PIN diode (12) which includes a p-type doped region (26) and an n-type doped region (24) separated by an amorphous silicon intrinsic region (25), wherein the intrinsic region overlies and contacts at least a part of one of the polycrystalline silicon islands which provides one of the p-type or n-type doped regions.
- 6. (Original) An active matrix pixel device according to Claim 5, wherein the source/drain regions (16,17) and said one of the p-type or n-type doped regions (26,24) of the PIN diode are provided by the same polycrystalline silicon island.
- 7. (Previously Presented) An active matrix pixel device according to Claim 5, wherein both the p-type and n-type doped regions of the PIN diode are provided by respective ones of the polycrystalline silicon islands.
- 8. (Original) An active matrix pixel device according to Claim 7, further comprising a second thin film transistor (10b) having doped source/drain regions (16b,17b) provided by one of the

islands, the doped source/drain regions (16b,17b) being of an opposite conductivity type to those of the first transistor (16a,17a), wherein the n-type doped region (24) of the PIN diode is provided by a doped source/drain region (17a) of one transistor and the p-type doped region (26) of the PIN diode is provided by a doped source/drain region (16b) of the other transistor.

- 9. (Previously Presented) An active matrix pixel device according to Claim 7, wherein a transparent conductive gate (30) overlies the intrinsic region (25) of the PIN diode separated therefrom by an insulating layer (18), the gate serving to apply a voltage to the intrinsic region so as to control the conductivity between the n-type and p-type doped regions.
- 10. (Previously Presented) An active matrix pixel device according to Claim 5, wherein the transistor further comprises a gate electrode (20) which serves to control the current through the channel, and wherein the amorphous silicon intrinsic region of the PIN diode overlies the gate electrode.
- 11. (Currently Amended) An active matrix electroluminescent display device according to claim ±5, wherein the PIN diode serves to measure the light intensity output (100) from an associated display element and supply a signal to drive circuitry connected thereto to enable modulation of the light output in accordance with the measured light intensity.